



MOTOROLA

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MC3346

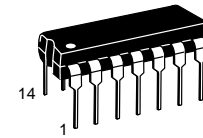
General Purpose Transistor Array One Differentially Connected Pair and Three Isolated Transistor Arrays

The MC3346 is designed for general purpose, low power applications for consumer and industrial designs.

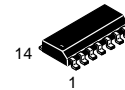
- Guaranteed Base–Emitter Voltage Matching
- Operating Current Range Specified: 10 μ A to 10 mA
- Five General Purpose Transistors in One Package

GENERAL PURPOSE TRANSISTOR ARRAY

SEMICONDUCTOR TECHNICAL DATA



P SUFFIX
PLASTIC PACKAGE
CASE 646



D SUFFIX
PLASTIC PACKAGE
CASE 751A
(SO-14)

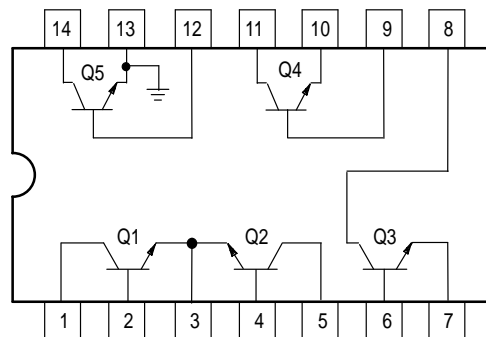
MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	15	Vdc
Collector–Base Voltage	V_{CBO}	20	Vdc
Emitter–Base Voltage	V_{EB}	5.0	Vdc
Collector–Substrate Voltage	V_{CIO}	20	Vdc
Collector Current – Continuous	I_C	50	mAdc
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	1.2 10	W mW/ $^\circ\text{C}$
Operating Temperature Range	T_A	-40 to +85	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-65 to +150	$^\circ\text{C}$

ORDERING INFORMATION

Device	Operating Temperature Range	Package
MC3346D	$T_A = -40^\circ$ to $+85^\circ\text{C}$	SO-14
MC3356P		Plastic DIP

PIN CONNECTIONS



Pin 13 is connected to substrate and must remain at the lowest circuit potential.

MC3346

ELECTRICAL CHARACTERISTICS (T_A = +25°C, unless otherwise noted.)

Characteristics	Symbol	Min	Typ	Max	Unit
STATIC CHARACTERISTICS					
Collector–Base Breakdown Voltage (I _C = 10 μAdc)	V _{(BR)CBO}	20	60	–	Vdc
Collector–Emitter Breakdown Voltage (I _C = 1.0 mAdc)	V _{(BR)CEO}	15	–	–	Vdc
Collector–Substrate Breakdown Voltage (I _C = 10 μA)	V _{(BR)CIO}	20	60	–	Vdc
Emitter–Base Breakdown Voltage (I _E = 10 μAdc)	V _{(BR)EBO}	5.0	7.0	–	Vdc
Collector–Base Cutoff Current (V _{CB} = 10 Vdc, I _E = 0)	I _{CBO}	–	–	40	nAdc
DC Current Gain (I _C = 10 mAdc, V _{CE} = 3.0 Vdc) (I _C = 1.0 mAdc, V _{CE} = 3.0 Vdc) (I _C = 10 μAdc, V _{CE} = 3.0 Vdc)	h _{FE}	– 40 –	140 130 60	– – –	–
Base–Emitter Voltage (V _{CE} = 3.0 Vdc, I _E = 1.0 mAdc) (V _{CE} = 3.0 Vdc, I _E = 10 mAdc)	V _{BE}	– –	0.72 0.8	– –	Vdc
Input Offset Current for Matched Pair Q1 and Q2 (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc)	I _{O1} – I _{O2}	–	0.3	2.0	μAdc
Magnitude of Input Offset Voltage (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc)	–	–	0.5	5.0	mVdc
Temperature Coefficient of Base–Emitter Voltage (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc)	$\frac{\Delta V_{BE}}{D_T}$	–	–1.9	–	mV/°C
Temperature Coefficient	$\frac{ \Delta V_{IO} }{D_T}$	–	1.0	–	μV/°C
Collector–Emitter Cutoff Current (V _{CE} = 10 Vdc, I _B = 0)	I _{CEO}	–	–	0.5	μAdc

DYNAMIC CHARACTERISTICS

Low Frequency Noise Figure (V _{CE} = 3.0 Vdc, I _C = 100 μAdc, R _S = 1.0 kΩ, f = 1.0 kHz)	NF	–	3.25	–	dB
Forward Current Transfer Ratio (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc, f = 1.0 kHz)	h _{FE}	–	110	–	–
Short Circuit Input Impedance (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc)	h _{ie}	–	3.5	–	kΩ
Open Circuit Output Impedance (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc)	h _{oe}	–	15.6	–	μmhos
Reverse Voltage Transfer Ratio (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc)	h _{re}	–	1.8	–	x10 ^{–4}
Forward Transfer Admittance (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc, f = 1.0 MHz)	y _{fe}	–	31–j1.5	–	–
Input Admittance (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc, f = 1.0 MHz)	y _{ie}	–	0.3 + j0.04	–	–
Output Admittance (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc, f = 1.0 MHz)	y _{oe}	–	0.001 + j0.03	–	–
Current–Gain – Bandwidth Product (V _{CE} = 3.0 Vdc, I _C = 3.0 mAdc)	f _T	300	550	–	MHz
Emitter–Base Capacitance (V _{EB} = 3.0 Vdc, I _E = 0)	C _{eb}	–	0.6	–	pF
Collector–Base Capacitance (V _{CB} = 3.0 Vdc, I _C = 0)	C _{cb}	–	0.58	–	pF
Collector–Substrate Capacitance (V _{CS} = 3.0 Vdc, I _C = 0)	C _{Cl}	–	2.8	–	pF

Figure 1. Collector Cutoff Current versus Temperature (Each Transistor)

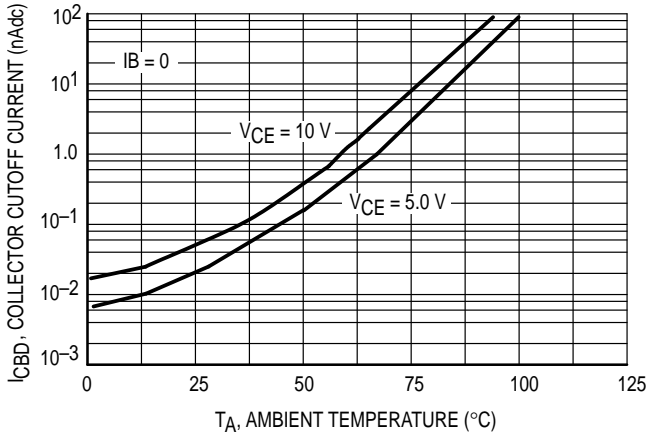


Figure 2. Collector Cutoff Current versus Temperature (Each Transistor)

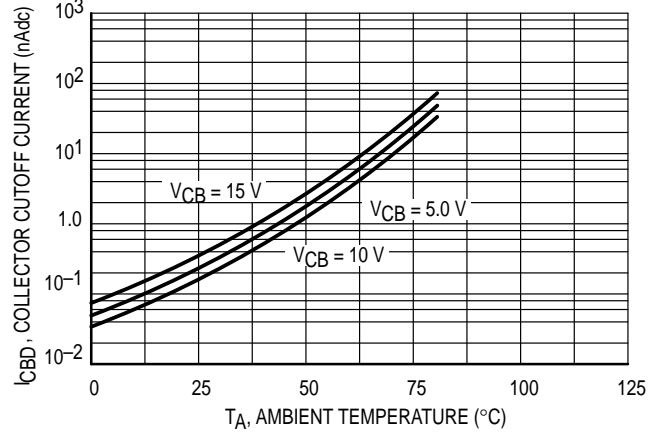


Figure 3. Input Offset Characteristics for Q1 and Q2

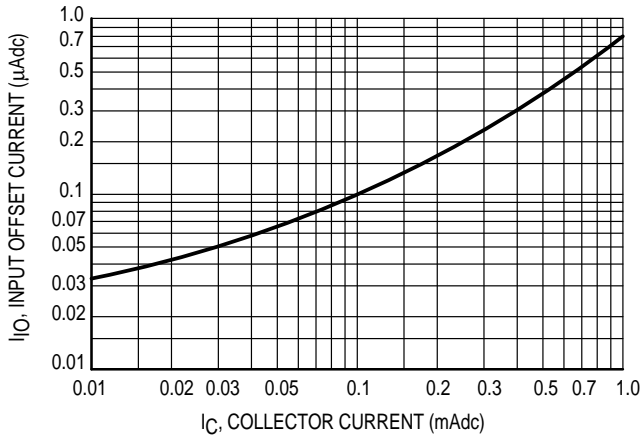


Figure 4. Base-Emitter and Input Offset Voltage Characteristics

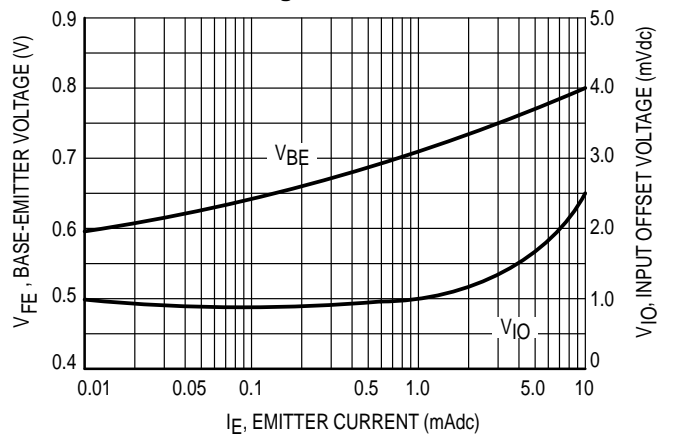
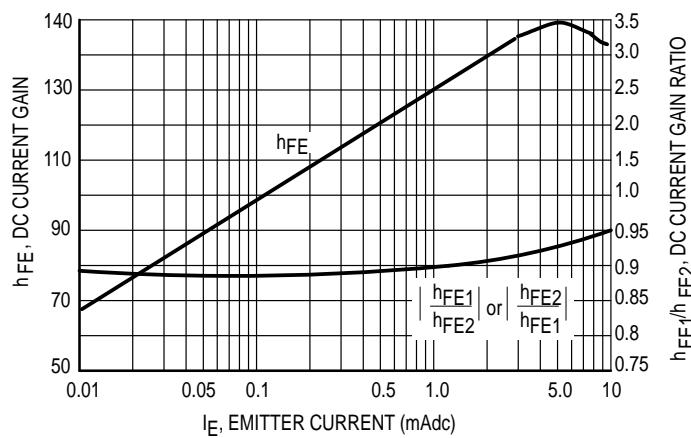


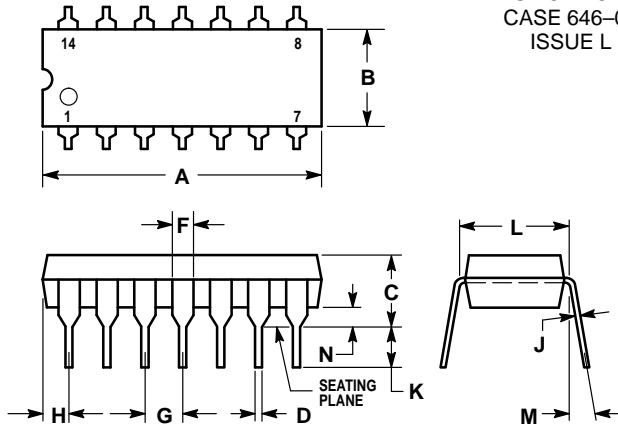
Figure 5. DC Current Gain



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OUTLINE DIMENSIONS

P SUFFIX PLASTIC PACKAGE CASE 646-06 ISSUE L

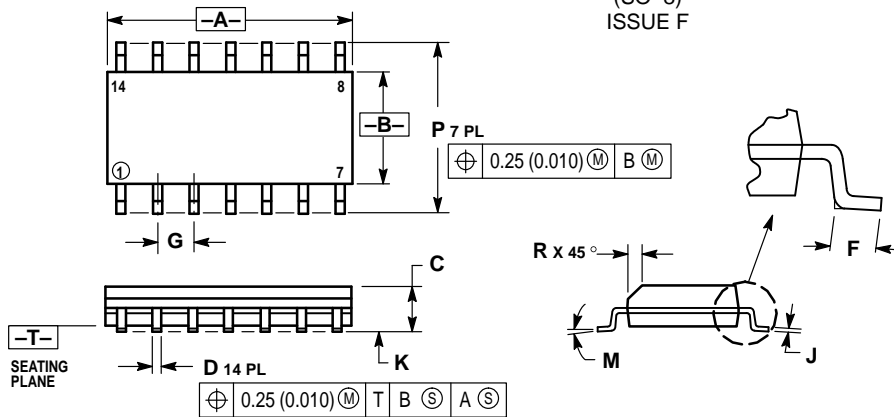


NOTES:

- LEADS WITHIN 0.13 (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.
- ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.715	0.770	18.16	19.56
B	0.240	0.260	6.10	6.60
C	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100 BSC		2.54 BSC	
H	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.300 BSC		7.62 BSC	
M	0°	10°	0°	10°
N	0.015	0.039	0.39	1.01

D SUFFIX PLASTIC PACKAGE CASE 751A-03 (SO-8) ISSUE F



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

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